

Data sheet

Part number : VCEW1154LDS-3C4K3-TR



2011/65/EU, (EU)2015/863
10 Substances regulation compliant



Lead-free solder heat resistant product

| | |
|------------------|--|
| Package | PLCC-2 package Outer dimension 3.5 x 2.8 x 1.9mm (L x W x H) |
| Product features | <ul style="list-style-type: none"> • Wide range temperature applicable product • High reliability (for automotive applications and other high-reliability required applications) • Lead-free soldering compatible • RoHS: 2011/65/EU, (EU)2015/863 compliant |

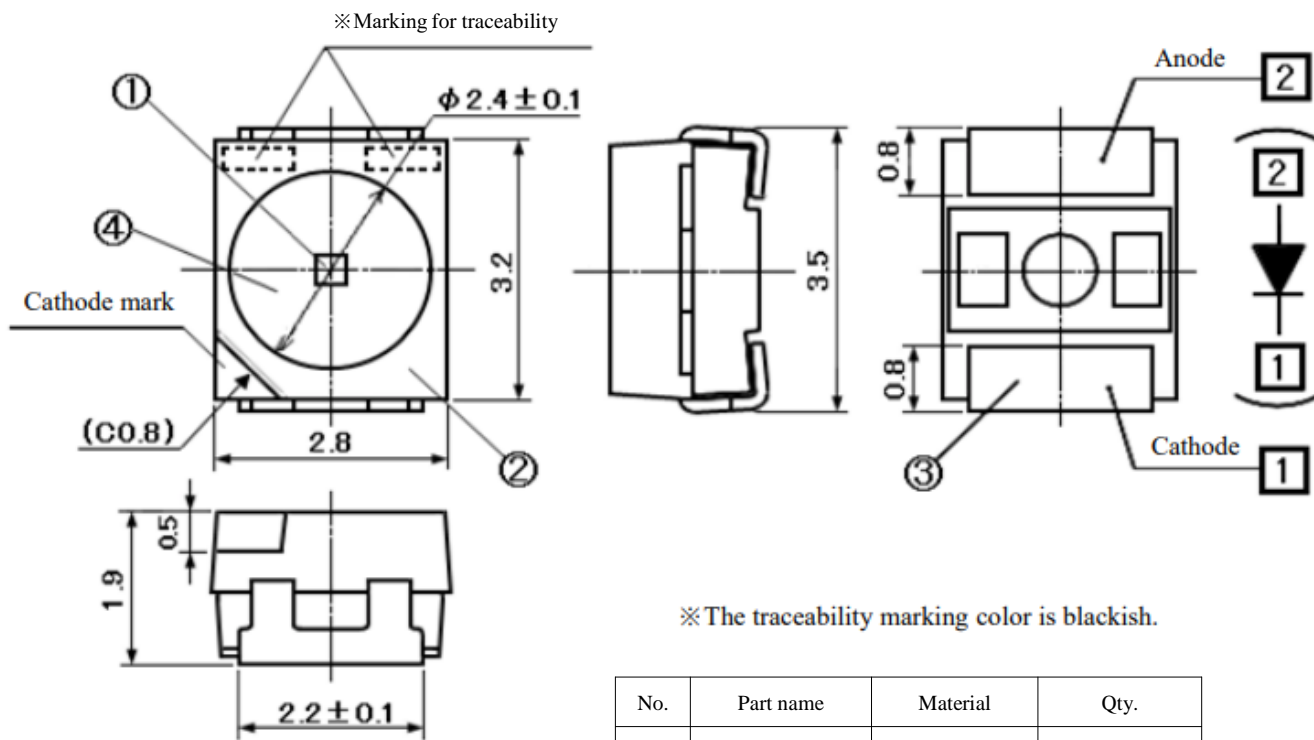
Recommended applications

- • Automotive interior: Switch and buttons , meter panel , car audio , HVAC, other various indicator etc.

Outline dimensions

VCEW1154LDS-3C4K3-TR

Unit : mm
 Weight : 33mg
 Tolerance : ±0.2

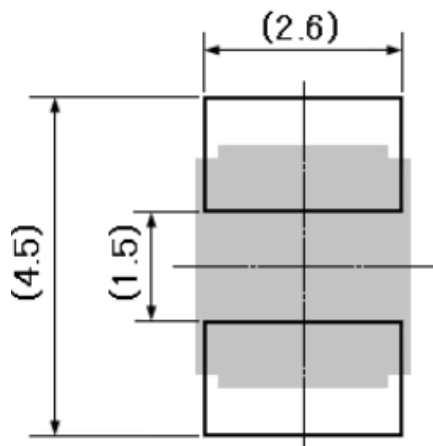


※ The traceability marking color is blackish.

| No. | Part name | Material | Qty. |
|-----|--------------|----------------|------|
| ① | LED die | InGaN | 1 |
| ② | Lamp housing | White resin | 1 |
| ③ | Electrode | Au/Pd plating | 2 |
| ④ | Encapsulant | Silicone resin | 1 |

Recommended soldering pattern

Unit : mm



Specifications

VCEW1154LDS-3C4K3-TR

【 Product Overview 】

| | |
|-----------------------------|----------------------|
| Die Material | InGaN |
| Emitting Color | White |
| Resin Color(Emitting Area) | Diffused Pale Yellow |
| Resin Color(Lamp Housing) | White |

【 Absolute Maximum Ratings 】

(Ta=25°C)

| ITEM | SYMBOL | MAXIMUM RATINGS | UNITS | |
|--|------------------|-----------------|-------|-------|
| Power Dissipation | P_d | 76 | mW | |
| Forward Current | I_F | 20 | mA | |
| Repetitive Peak Forward Current "1ms, 1/10duty" | I_{FRM} | 100 | mA | |
| I_F Derate Linearly from "85°C" | ΔI_F | 0.57 | mA/°C | |
| I_{FRM} Derate Linearly from "85°C" | ΔI_{FRM} | 2.86 | mA/°C | |
| Reverse Voltage | V_R | 5 | V | |
| Operating Temperature | T_{opr} | -40 to +100 | °C | |
| Storage Temperature | T_{stg} | -40 to +120 | °C | |
| Electrostatic Discharge Threshold "HBM" | ESD | 1,000 | V | Note1 |
| Soldering Temperature "Reflow Soldering" | T_{sld} | 260 | °C | Note2 |

Note 1 ESD testing method : EIAJ4701/300(304) Human Body Model(HBM) 1.5kΩ,100pF

Note 2 Please refer to page 10, Soldering Conditions.

【 Thermal Characteristics 】

(Ta=25°C)

| ITEM | SYMBOL | TYP. | MAX. | UNITS | |
|---|---------------|------|------|-------|-------|
| Thermal Resistance 【Junction - Ambient】 | $R_{th(j-a)}$ | 300 | - | °C/W | Note3 |
| Thermal Resistance 【Junction - Solder point】 | $R_{th(j-s)}$ | 150 | - | °C/W | |

Note3 $R_{th(j-a)}$ Measurement Condition
Substrate:FR-4 (t=1.6mm)
Pattern Size : 16mm²

Specifications

VCEW1154LDS-3C4K3-TR

【 Electro and Optical Characteristics 】

| | | | | | | | (Ta=25°C) |
|--------------------------|------------------|---------------------|------|-------|------|---------------|-----------|
| ITEM | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Forward Voltage | V_F | $I_F = 10\text{mA}$ | 2.7 | 3.1 | 3.5 | V | Notes4 |
| Reverse Current | I_R | $V_R = 5\text{V}$ | - | - | 10 | μA | |
| Luminous Intensity | I_V | $I_F = 10\text{mA}$ | 180 | 250 | 330 | mcd | Notes5 |
| Luminous Flux | ϕ_V | $I_F = 10\text{mA}$ | - | 0.75 | - | lm | |
| Chromaticity Coordinates | x | $I_F = 10\text{mA}$ | - | 0.304 | - | / | Notes6,7 |
| | y | | - | 0.298 | - | | |
| Half Intensity Angle | $\Delta\theta_x$ | $I_F = 10\text{mA}$ | - | 115 | - | deg. | Notes8 |
| | $\Delta\theta_y$ | | - | 115 | - | | |

Notes 4 【Tolerance : $\pm 0.1\text{V}$ 】

Notes 5,6 Please refer to following each sorting chart.

Above the table of Luminous Intensity (I_V) values and Dominant Wavelength (λ_d) values are the setup value of the selection machine. 【Tolerance : $I_V \pm 10\%$ 、 $\lambda_d \pm 1\text{nm}$ 】

Notes7 Chromaticity coordinates : x and y according to CIE1931

Notes8 Viewing Angle at 50% I_V , $\Delta\theta_x$; Housing long side axis, $\Delta\theta_y$; Housing short side axis

【 Sorting Chart for Luminous Intensity 】

LED's shall be sorted out into the following ranks of Luminous Intensity.

| Luminous Intensity (I_V) Rank | | | |
|-----------------------------------|-------------|------|---------------------------------|
| Rank | I_V (mcd) | | Conditions |
| | MIN. | MAX. | |
| C4 | 180 | 220 | Ta=25°C I _F =10mA |
| C5 | 220 | 270 | |
| C6 | 270 | 330 | |

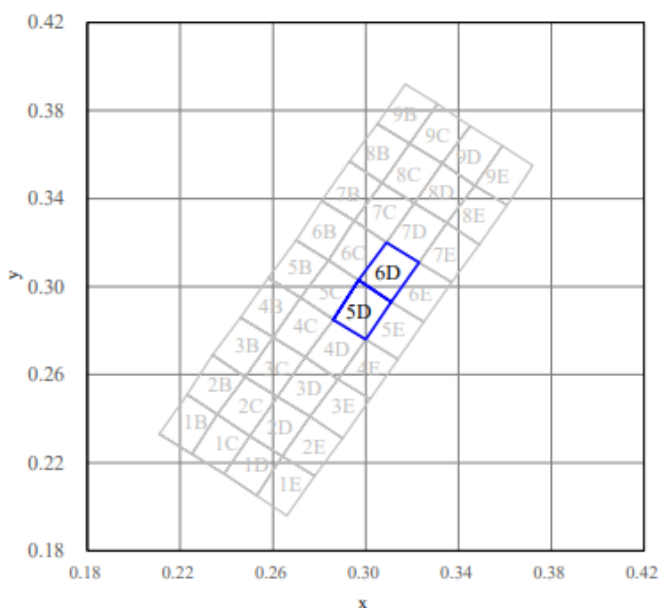
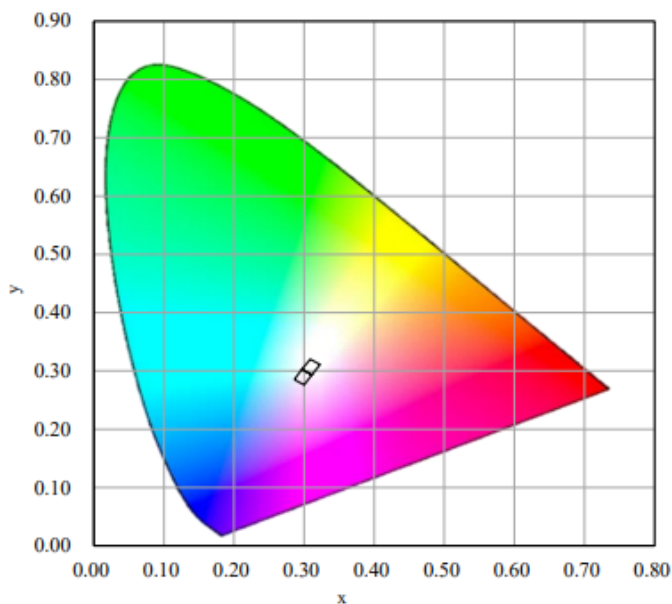
Note: 【Tolerance : $I_V \dots \pm 10\%$ 】

Specifications

VCEW1154LDS-3C4K3-TR

【 Sorting chart for chromaticity : x , y 】

LEDs shall be sorted out into the following chart and each rank shall be packed separately for shipping.

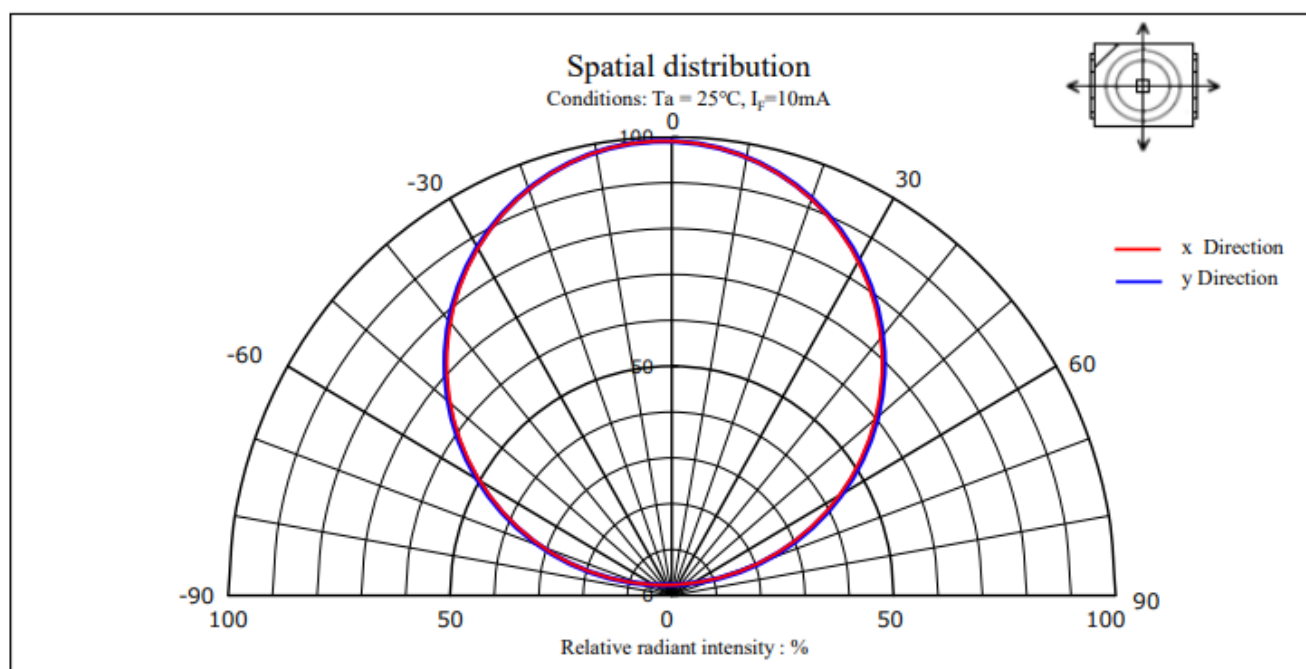
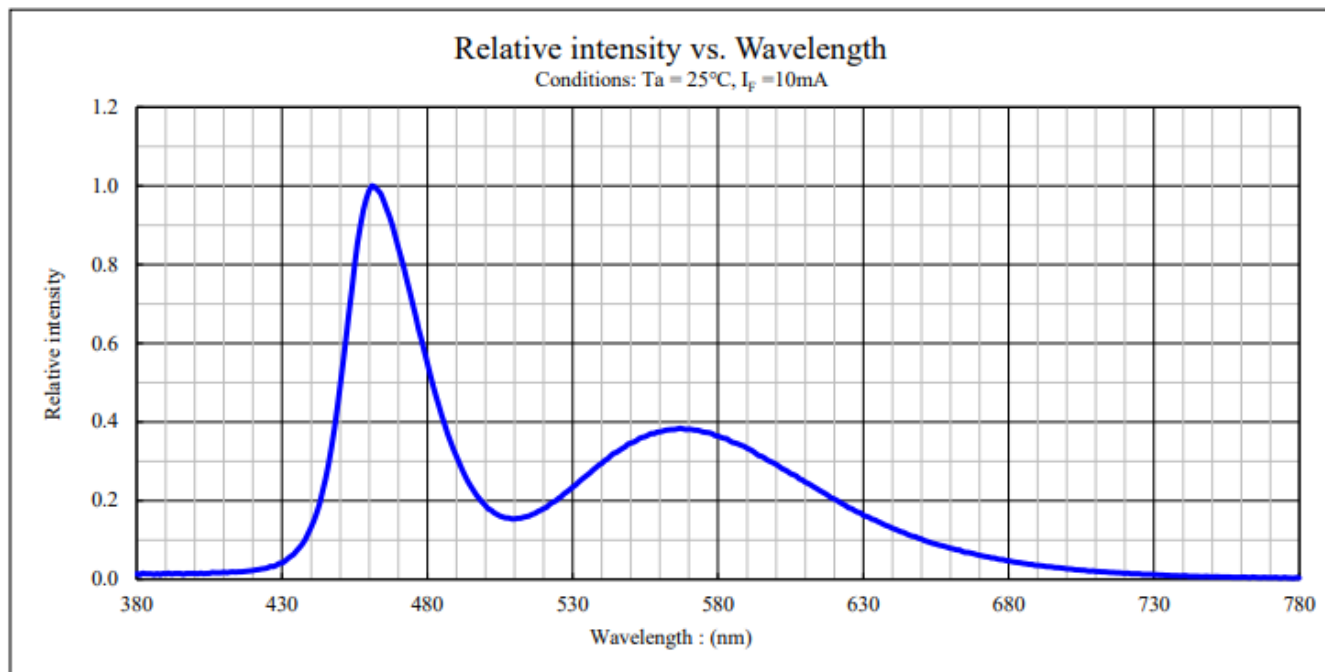


($I_F=10\text{mA}$, $T_a=25^\circ\text{C}$)

| Rank | Left down | | Left upper | | Right upper | | Right down | |
|------|-----------|-------|------------|-------|-------------|-------|------------|-------|
| | x | y | x | y | x | y | x | y |
| 5D | 0.286 | 0.285 | 0.297 | 0.303 | 0.311 | 0.293 | 0.300 | 0.276 |
| 6D | 0.297 | 0.303 | 0.309 | 0.320 | 0.323 | 0.311 | 0.311 | 0.293 |

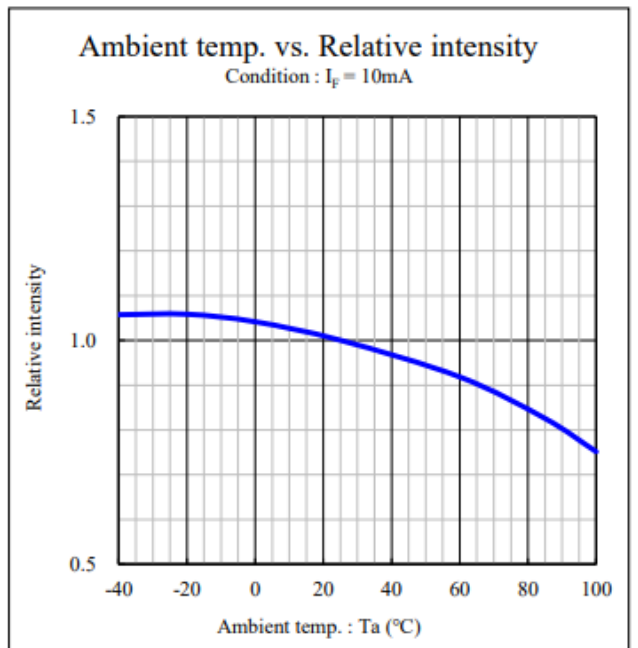
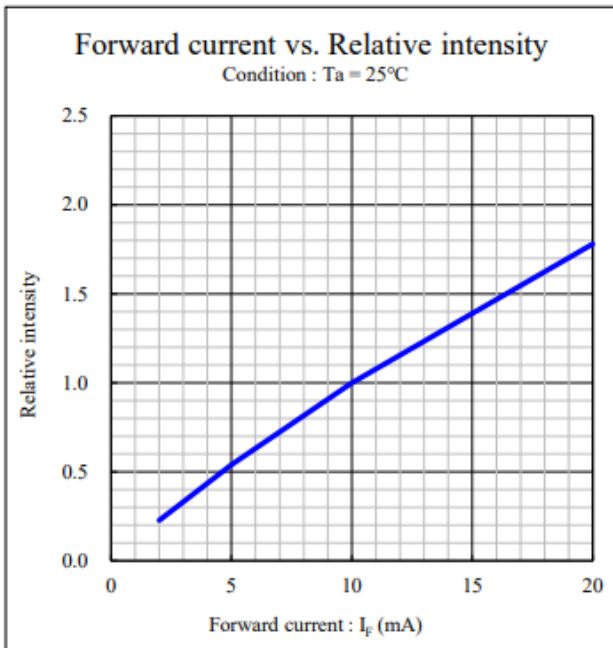
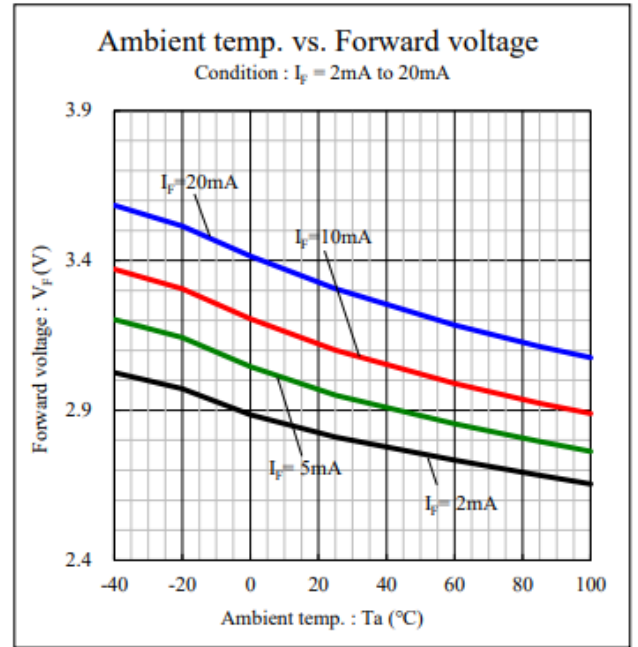
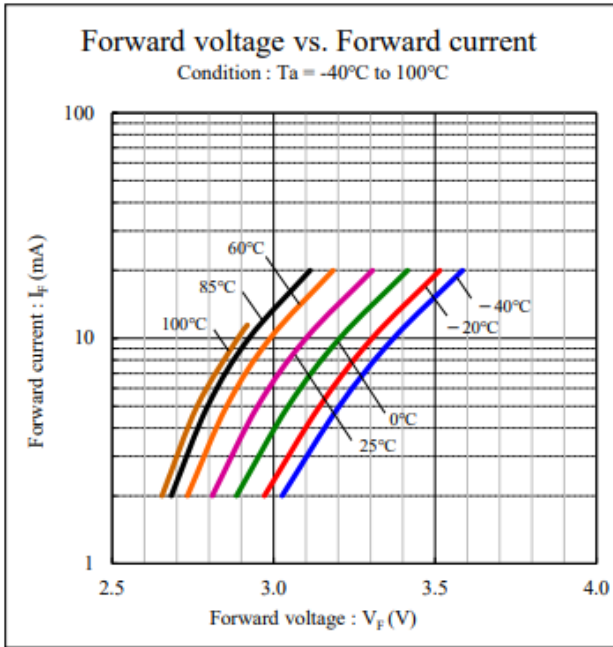
Technical Data

VCEW1154LDS-3C4K3-TR



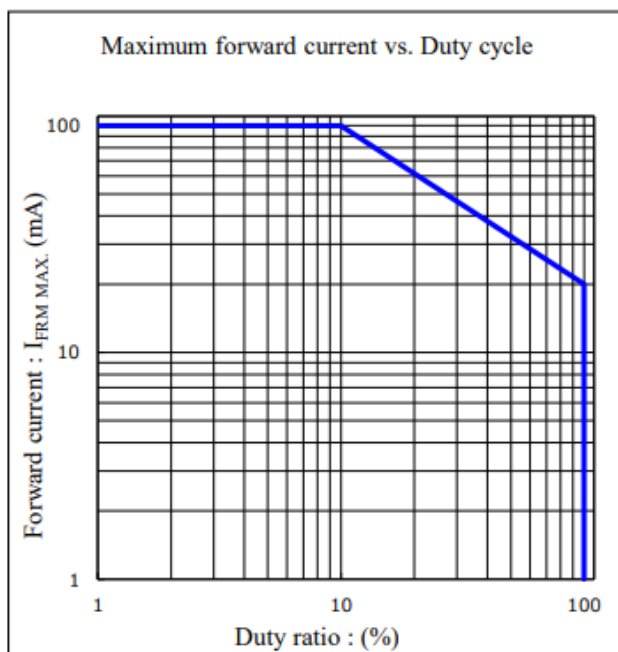
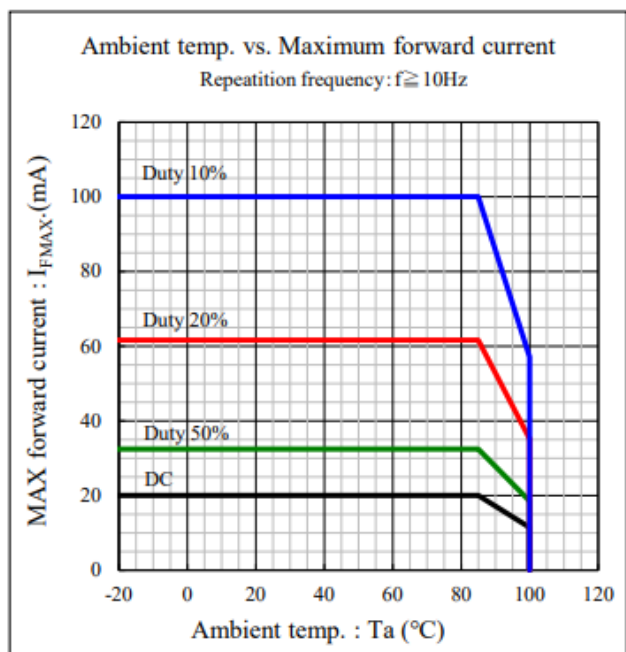
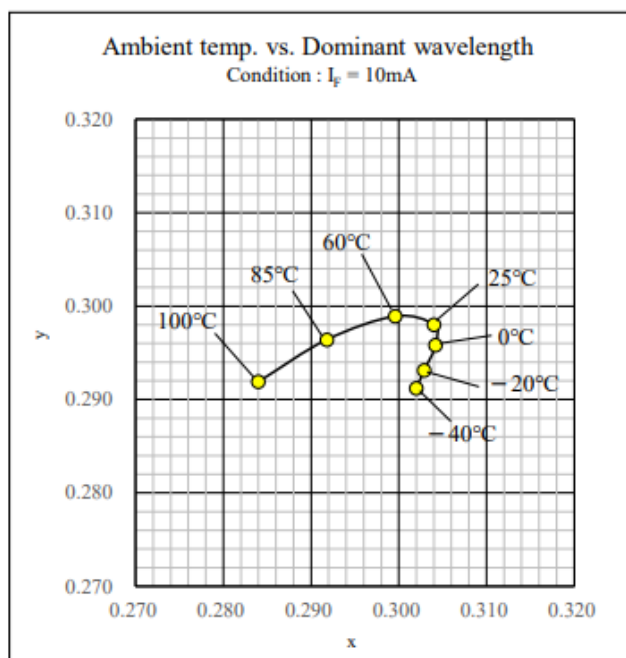
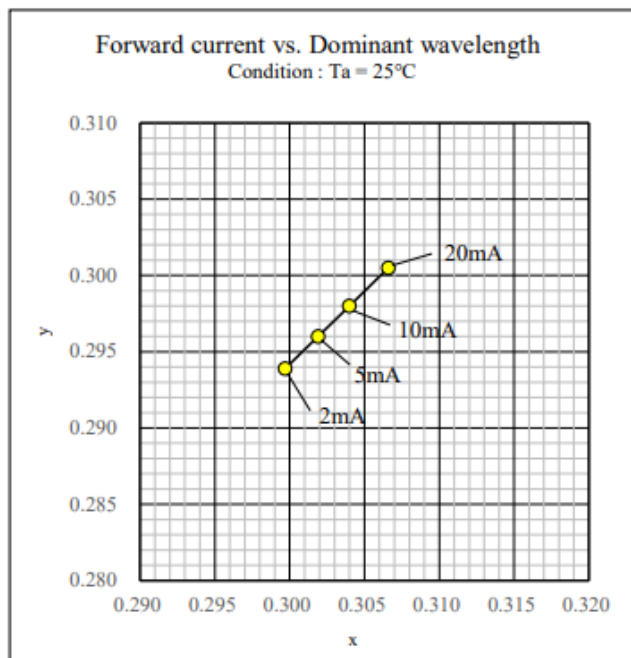
Technical Data

VCEW1154LDS-3C4K3-TR



Technical Data

VCEW1154LDS-3C4K3-TR



Soldering condition

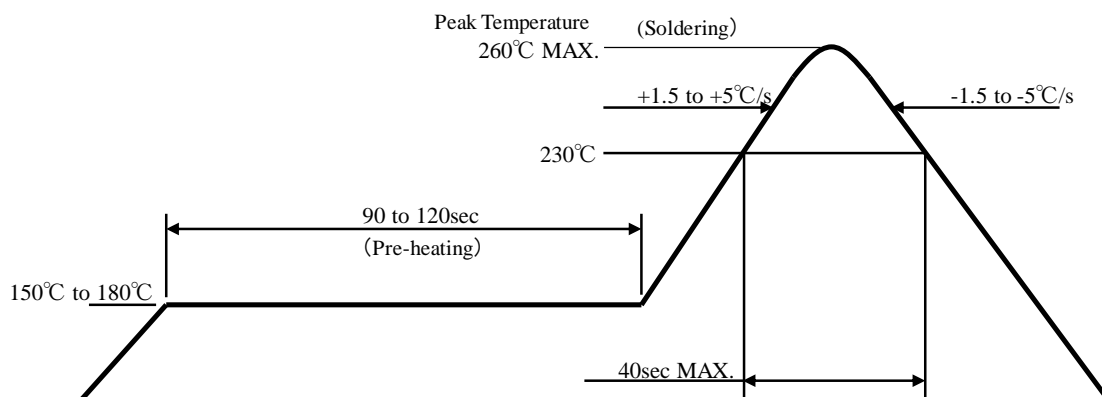
VCEW1154LDS-3C4K3-TR

【Soldering Precaution】

(acc.to EIAJ-4701/300)

1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).
2. LED parts including the resin are not stable immediately after soldering (when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.
3. Recommended temperature profile for the reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .
Please do not repeat the heating process in reflow process more than 2 times.

【Recommended Reflow Soldering Condition】



Note 1 Temperature profile for the reflow should be set to the surface temperature of resin which is on the top of LED. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to 2 times Max. When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.

Soldering condition

VCEW1154LDS-3C4K3-TR

4. If soldering manually, the peak temperature changes according to the size of land and the shape of soldering iron tip. Therefore please confirm there is no problem before usage. Also, Stanley recommends using a soldering iron equipped with temperature control and the peak temperature to be lowered.
During the actual soldering process, make sure that the soldering iron never touches the LED itself, and avoid the LED's electrode temperature reaching above the temperature of the solder pad.
All repairs must be performed only once in the same spot, and please avoid reusing components.
5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature, then use it. Also, please avoid applying any types of pressure to the soldered components before the solder is cooling and hardening, as it may deteriorate solder performance and solder quality.

【Recommended manual soldering condition】

| | |
|--------------------------|--------------------|
| Temperature of iron tip | 350°C max. |
| Soldering duration, time | 3sec. max., 1 time |

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation(UV) setting resin with heat shall be recommended.
《Curing condition, Temperature:150°C max. / Time:120sec.max.》
7. Flow soldering (dip soldering) is not guaranteed for this product.
8. Please confirm in advance there is no problem by assessment on your side if cleaning process is necessary.
We can not accept any quality issues caused by the cleaning process.
As this product uses the low hardness silicone resin for the lens, please avoid cleaning to give pressure on the surface of the resin.
Please make sure ultrasonic cleaning is not recommended for this product as well.
We will recommend isopropyl alcohol as a solvent used for cleaning.
Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on.
Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component before using.

| Cleaning agents | Recommended / Not recommended |
|-------------------|-------------------------------|
| Isopropyl Alcohol | ✓ Recommended |
| Trichloroethylene | x Not recommended |
| Chloroethene | x Not recommended |
| Acetone | x Not recommended |
| Thinner | x Not recommended |

Handling precautions

VCEW1154LDS-3C4K3-TR

【For electrostatic discharge (ESD)】

LED with an InGaN die is sensitive to voltage surges generated by On/Off status change and friction with synthetic materials, which may cause severe damage to the die or undermine its reliability. Damaged products may experience conditions such as extremely high reverse voltage, decrease of forward rise voltage, deterioration in optical characteristics.

Stanley InGaN products are packed with anti-static components. However, following precautions must be taken into account upon product shipment.

1. Electrification/static electricity protection

In order to avoid product (die) damage from static electricity caused by unprotected handling by operator and other charged materials coming in contact with the product, Stanley recommends taking the following precautions.

- ① Do not place electrified non-conductive materials near the LED product.
Avoid LED products from coming into contact with metallic materials.(Should the metallic material be electrified , the sudden surge voltage will most likely damage the product.)
- ② Avoid a working process which may cause the LED product to rub against other materials.
- ③ Install ground wires for any equipment, where they can be installed, with measures to avoid static electricity surges.
- ④ Prepare a ESD protective area by placing a Conductive Mattress (1MΩ MAX.) and Ionizer to remove any static electricity.
- ⑤ Operators should wear a protective wrist-strap.
- ⑥ Operators should wear conductive work-clothes and shoes.
- ⑦ To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

2. Working environment

- ① A dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.
- ② Recommended static electricity level in the working environment is less than 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

Handling precautions

VCEW1154LDS-3C4K3-TR

【Other precautions】


1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions
2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress(temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken into account for designing. (Derating of TYP., MAX Forward Voltage, etc.)
4. Please insert Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please avoid the stick of foreign material because molding resin in the products have adhesiveness. Also please don't touch lens portion.
6. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
7. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
8. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
9. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
10. When there is a process of supersonic wave welding etc. after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please make sure there is no problem before using.
11. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

Handling precautions

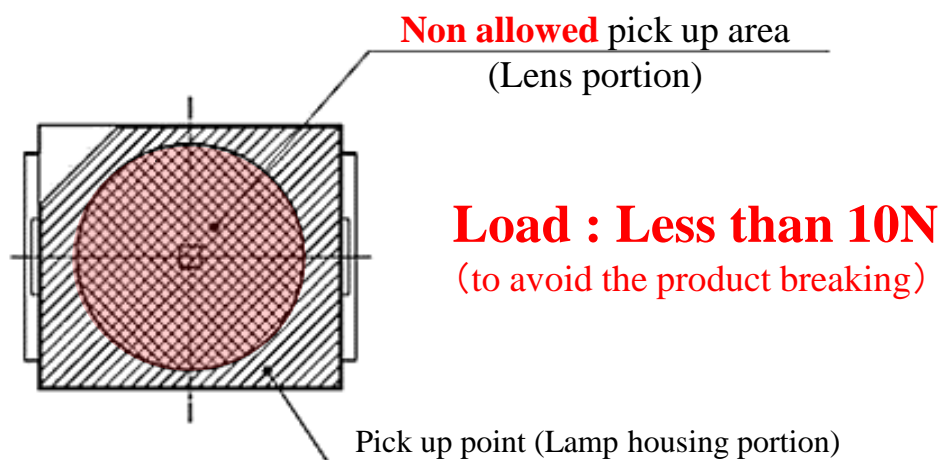
VCEW1154LDS-3C4K3-TR

【Handling precautions for product mounting】

<Recommendation>

1. Picking up point with nozzle : Lamp housing of the product ( area : Shown below)

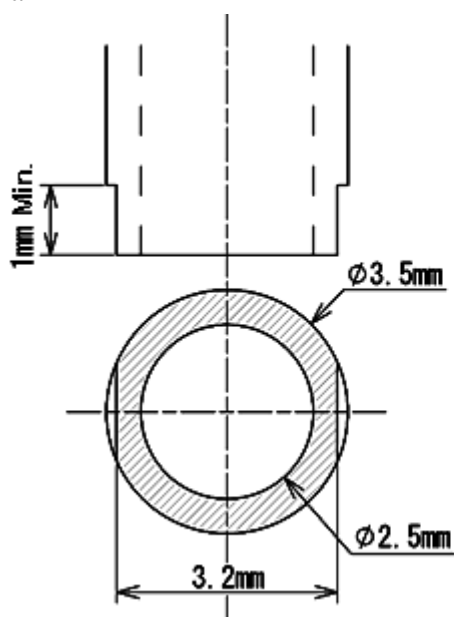
The pick up point is lamp housing only because the silicone resin used for the lens is soft.
(If the nozzle makes contact with the lens, the products might be destroyed)



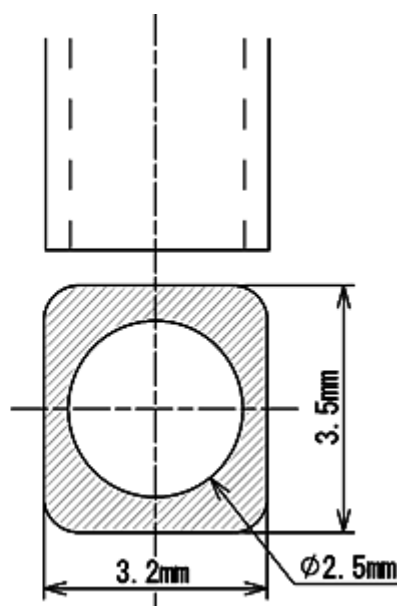
Please adjust the load, the pick up point, the nozzle diameter and etc. before mounting because the over load can cause the breakage of the lamp housing.

2. Recommended nozzle shape

a



b



※ Nozzle with chamfering is recommended

Packaging specifications

VCEW1154LDS-3C4K3-TR

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

【Recommended storage condition / products warranty period】

| | |
|-------------|-----------|
| Temperature | +5~30°C |
| Humidity | Under 70% |

In the case of the package unopened, please use within **6 months** **【Recommended storage condition】**. Please avoid rapid transition from low temp. condition to high temp. condition and storage in corroding and dusty environment.

【Time elapsed after package opening】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering which is **【maximum 672h】**. If the device needs to be soldered twice, both soldering operations must be completed within the 72h.

If any components should remain unused, please reseal the package and store them under the conditions described in the **【 Recommended Storage Condition 】** above.

This product must be required to perform baking process (moisture removal) for **at 48h (min.) to 72h (max.) at 60±5 degrees Celsius** if following conditions apply.

1. In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its blue color.
2. In the case of time passes for 672h after the package is opened once.

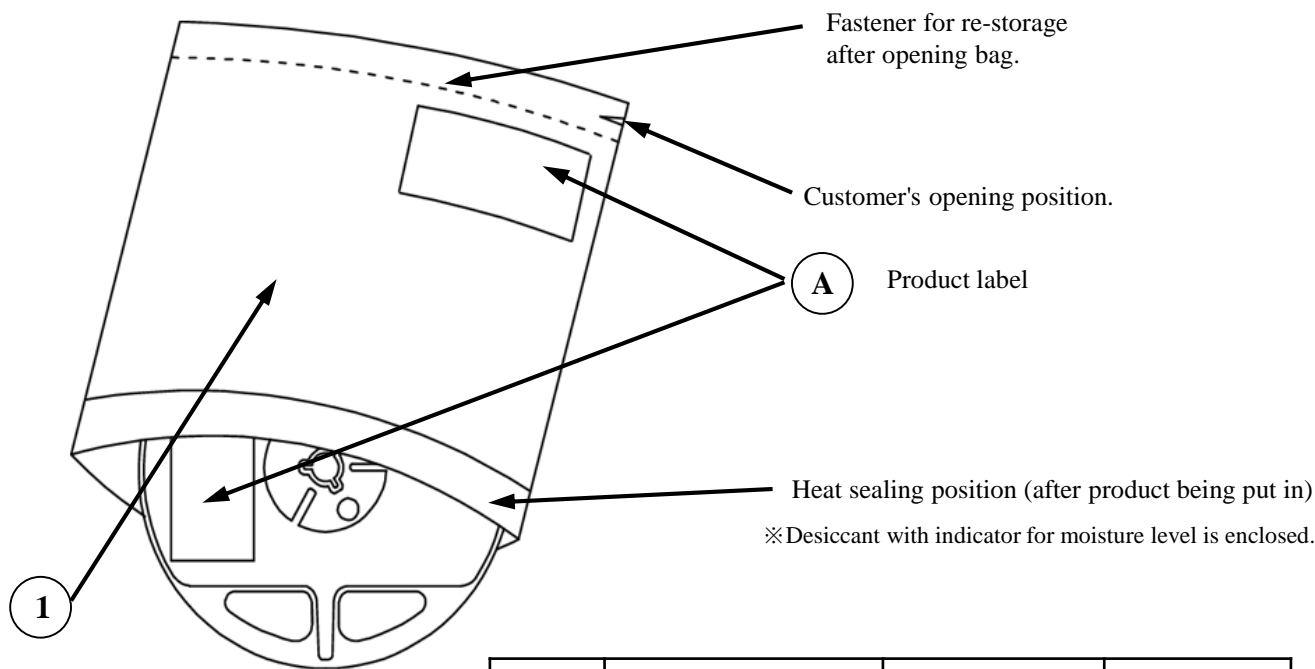
Baking process should be performed after LED having been taken out of the package.

Baking may be performed in the tape-reel form, however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times max.

Packaging specifications

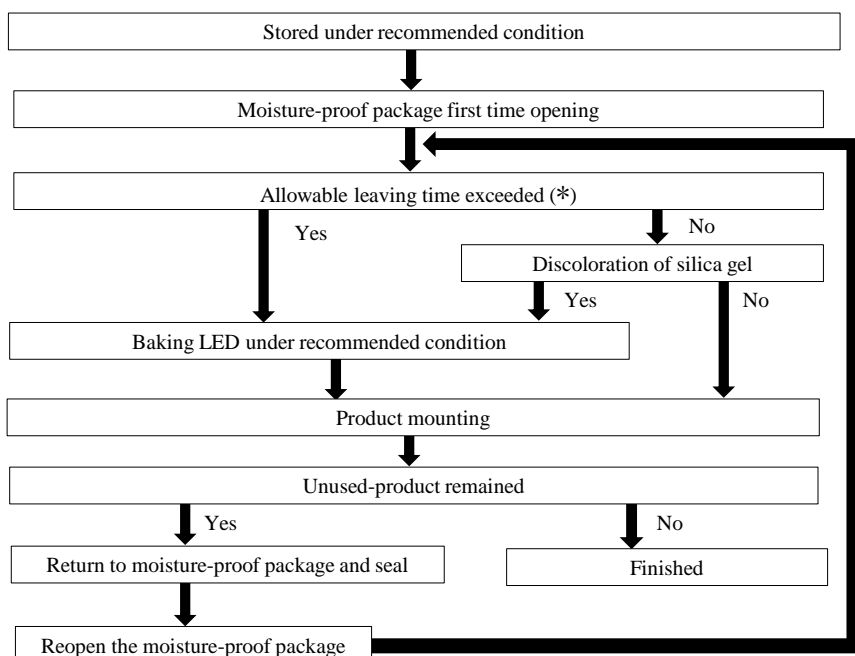
VCEW1154LDS-3C4K3-TR

【Moisture-proof packaging specification】



| No. | Part name | Material | Remarks |
|-----|--|-----------|---------------------|
| ① | Moisture-proof bag with Aluminum layer | PET+Al+PE | with ESD protection |

【Flow chart-package opening to mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type. The allowable leaving time should be calculated from the first opening of package to the time when soldering process is finished. When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated from the first opening of package, or from the time when baking process is finished.

Packaging specifications

VCEW1154LDS-3C4K3-TR

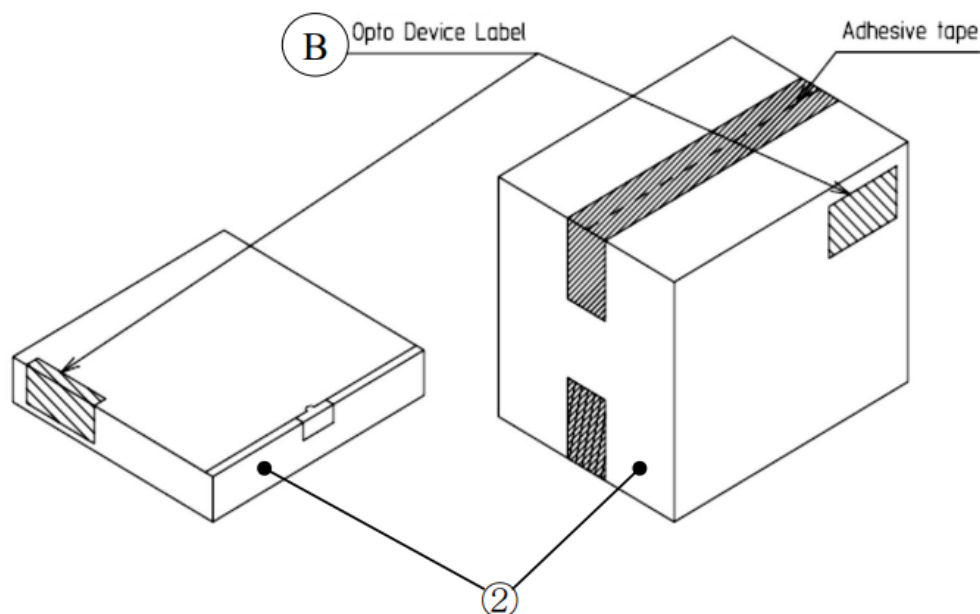
【Packing box】

(RoHS2 / ELV Compliant)

| Box type | Outline dimension L × W × H (mm) | Capacity of the box |
|----------|-------------------------------------|---------------------|
| Type A | 280 × 265 × 45 | 3 reels |
| Type B | 310 × 235 × 265 | 15 reels |
| Type C | 440 × 310 × 265 | 30 reels |
| Type D | 305 × 270 × 65 | 3 reels |
| Type E | 370 × 280 × 270 | 30 reels |
| Type F | 530 × 380 × 270 | 60 reels |

The above measurements are reference values.

The box is selected out of the above table by shipping quantity.



Type A

Material / box : Cardboard C5BF

Type B, C

Material / box : Cardboard K5AF

Partition : Cardboard K5BF

Type D

Material / box : Cardboard C5WF

Type E, F

Material / box : Cardboard BC-KA125/3CA125/KA125

| No. | Part name | Material | Remarks |
|-----|-------------|----------------------|------------------------|
| ② | Packing box | Corrugated cardboard | without ESD protection |

Packaging specifications

VCEW1154LDS-3C4K3-TR

(acc.to JIS-X0503(Code-39))

【Label specification】

A Product label

The diagram shows a rectangular label with the following layout:

- Top header: **STANLEY -STANLEY ELECTRIC CO.,LTD.-**
- Field A: A small box containing a barcode.
- Field B: A larger box containing a barcode.
- Field C: A box containing a code, followed by a closing parenthesis.)
- Field D: A box containing a code, followed by "PCS".
- Field E: A box containing a barcode.
- Field F: A box containing a code, followed by "Lot No." and another box.
- Field G: A large box containing a barcode.

- A. Parts number
 - B. Bar-code for parts number
 - C. Parts code (In-house identification code for each parts number)
 - D. Packed parts quantity
 - E. Bar-Code for packed parts quantity
 - F. Lot number & rank
- (Please refer to lot number notational system for details)
- G. Bar-code for lot number & rank

B Opto device label

The diagram shows a rectangular label with the following layout:

- Top header: **STANLEY OPTO DEVICES**
- Field A: A box containing a code, followed by "御中" (Gomochi).
- Field B: A box containing a code.
- Field D: A box containing a code.
- Field C: A box containing a code, followed by a closing parenthesis.)
- Field E: A box containing a code, followed by "PCS".
- Field G: A box containing a code.
- Field F: A box containing a code, followed by "C/NO".
- Field H: A box containing a barcode.
- Bottom header: **STANLEY ELECTRIC CO.,LTD.**

- A. Customer name
- B. Parts type
- C. Parts code
- D. Parts number
- E. Packed parts quantity
- F. Carton number
- G. Shipping date
- H. Bar-code for In-house identification number

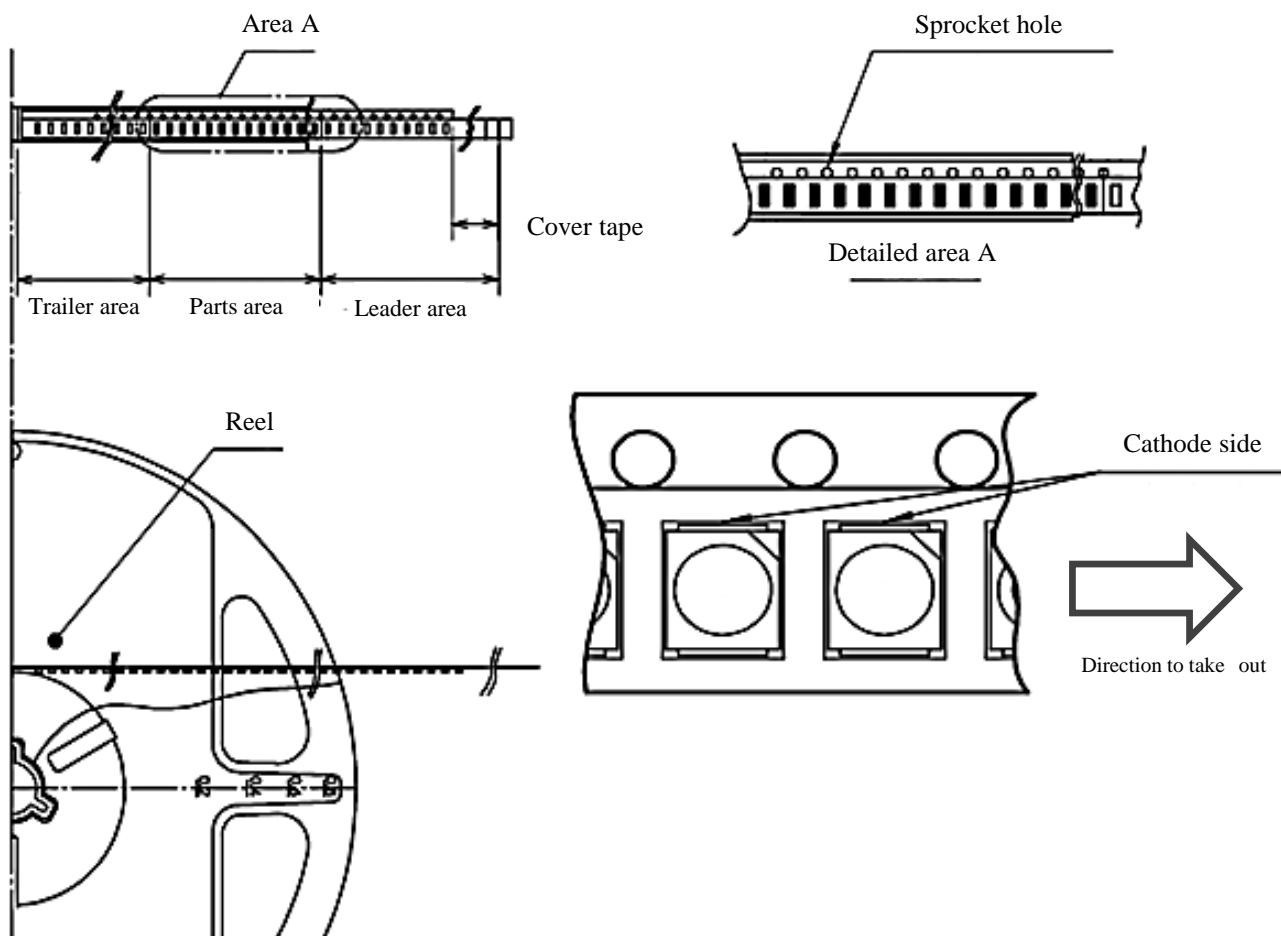
<Remarks> Bar-code font : acc.to Code-39(JIS-X0503)

Taping and reel specifications

VCEW1154LDS-3C4K3-TR

(acc.to JIS-C0806-03)

【Appearance】



Note

"-TR" means Cathode Side of LEDs; should be placed on the sprocket-hole side.

| Items | | Specifications | Remarks |
|--------------|--------------|---|--|
| Leader area | Cover-tape | Cover-tape shall be longer than 320mm without carrier-tape | The end of cover-tape shall be held with adhesive tape. |
| | Carrier-tape | Empty pocket shall be more than 20 pieces . | Please refer to the above figure for Taping & reel orientation . |
| Trailer area | | Empty pocket shall be more than 15 pieces . | The end of taping shall be inserted into a slit of the hub. |

Taping and reel specifications

VCEW1154LDS-3C4K3-TR

(acc.to JIS-C0806-03)

【 Qty. per reel】

2,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 3,000 parts.

In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label

【Mechanical strength】

Cover-tape adhesive strength shall be 0.1~1.0N (An angle between carrier-tape and cover-tape shall be 170 deg.).

Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

【 Others】

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held.

Empty pocket per reel shall be defined as follows.

| Qty./reel | Max. qty. of empty pocket | Remarks |
|-----------|---------------------------|----------------|
| 500 | 1 | - |
| 1,000 | 1 | - |
| 1,500 | 1 | - |
| 2,000 | 2 | No continuance |

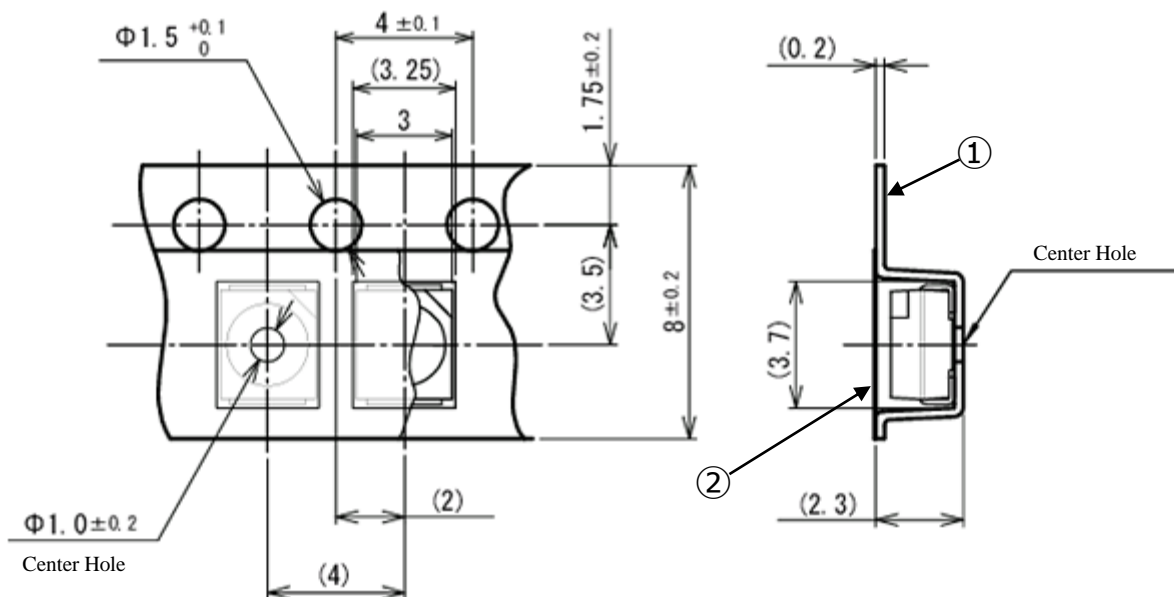
Taping and reel specifications

VCEW1154LDS-3C4K3-TR

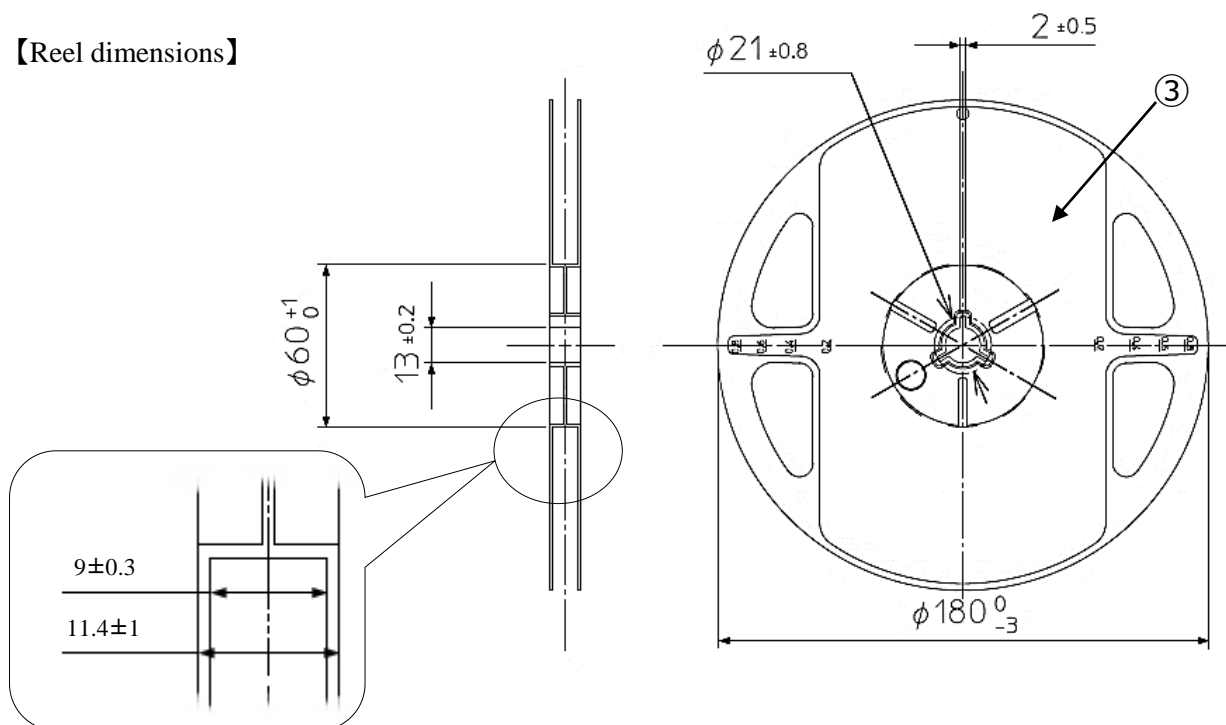
(acc.to JIS-C0806-03)

Unit: mm

【Taping dimensions】



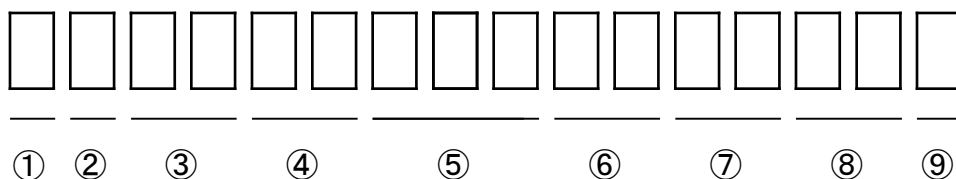
【Reel dimensions】



| No. | Part name | Remarks |
|-----|--------------|---------------------|
| ① | Carrier-tape | with ESD protection |
| ② | Cover-tape | with ESD protection |
| ③ | Carrier-reel | with ESD protection |

Lot number notational system

VCEW1154LDS-3C4K3-TR



① - 1digit : Production location (mark identify alphabet)

② - 1digit : Production year (The last digit of production year 2024→4, 2025→5, 2026→6, 2027→7 …)

③ - 2digits : Production month (Jan. to Sep. , should be 01,02,03 …)

④ - 2digits : Production date

⑤ - 3digits : Serial number

⑥ - 2digits : Tape and reel following number

⑦ - 2digits : Luminous intensity rank.

(If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified rank, "- -" is used to indicate.)

⑧ - 2digits : Chromaticity coordinates rank

(If chromaticity coordinates rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified rank, "- -" is used to indicate.)

⑨ - 1digit : VF Rank (If rank is not defined, "-" is described.)

Compliance with RoHS2/ELV

VCEW1154LDS-3C4K3-TR

This product is in compliance with RoHS / ELV.

Prohibition substance and it's criteria value of RoHS / ELV are as follows.

- RoHS instruction ... Refer to following 1 to 10.
- ELV instruction ... Refer to following 1 to 4.

2011/65/EU, (EU)2015/863

| No. | Substance group name | Maximum permissible concentration value |
|-----|---------------------------------------|---|
| 1 | Lead and its compounds | 1,000ppm (0.1%) |
| 2 | Cadmium and its compounds | 100ppm (0.01%) |
| 3 | Mercury and its compounds | 1,000ppm (0.1%) |
| 4 | Hexavalent chromium compounds | 1,000ppm (0.1%) |
| 5 | PBB : Polybrominated Biphenyls | 1,000ppm (0.1%) |
| 6 | PBDE : Polybrominated Biphenyl Ethers | 1,000ppm (0.1%) |
| 7 | DEHP : Bis (2-ethylhexyl) phthalate | 1,000ppm (0.1%) |
| 8 | BBP : Butyl benzyl phthalate | 1,000ppm (0.1%) |
| 9 | DBP : Dibutyl phthalate | 1,000ppm (0.1%) |
| 10 | DIBP : Diisobutyl phthalate | 1,000ppm (0.1%) |

Reliability Testing Result

VCEW1154LDS-3C4K3-TR

1. Reliability testing result

| Test Item | Reference Standard | Test Condition | | Failure |
|--|------------------------|--|--------------------|---------|
| Room Temperature Operating Life | EIAJ ED-4701 /100(101) | Ta=25°C I _F =20mA | 1,000h | 0 / 20 |
| High Temperature Operating Life | EIAJ ED-4701 /100(101) | Ta=85°C I _F =20mA | 1,000h | 0 / 20 |
| Low Temperature Operating Life | EIAJ ED-4701/100(101) | Ta=-40°C I _F =20mA | 1,000h | 0 / 20 |
| Wet High Temperature Operating Life | EIAJ ED-4701/100(102) | Ta=60°C 90% I _F =20mA | 1,000h | 0 / 20 |
| High Temperature Storage Life | EIAJ ED-4701/200(201) | Ta=120°C | 1,000h | 0 / 20 |
| Low Temperature Storage Life | EIAJ ED-4701/200(202) | Ta=-40°C | 1,000h | 0 / 20 |
| Wet High Temperature Storage Life | EIAJ ED-4701/100(101) | Ta=60°C Rh=90% | 1,000h | 0 / 20 |
| Thermal Shock | EIAJ ED-4701/100(105) | Ta=-40°C to 120°C (each 15min) | 1,000cycles | 0 / 20 |
| Thermal Shock Operating | EIAJ ED-4701/100(105) | Ta=-40°C(OFF) to 85°C(I _F =20mA ON) (each 15min) | 1,000cycles | 0 / 20 |
| Cycled Temperature Humidity Operating Life | EIAJ ED-4701/200(203) | Ta=-30°C to 80°C 95(2h) 8h/cycle I _F =20mA 5min on-off | 30 cycles | 0 / 20 |
| Resistance to Reflow Soldering | EIAJ ED-4701/300(301) | Moisture Soak : 30°C 70% 4weeks (672h) / Preheating : 150 to 180°C 90-120sec MAX. / Soldering : 260°C peak | 2times | 0 / 20 |
| Electrostatic Discharge (ESD) | EIAJ ED-4701/300(304) | C=100pF R2=1.5kΩ ±2,000V | once each polarity | 0 / 10 |
| Vibration, Variable Frequency | EIAJ ED-4701/400(403) | 98.1m/s ² (10G) 100 to 2,000Hz 20min XYZ direction | Each direction | 0 / 10 |

2. Failure criteria

| Item | Symbol | Condition | Failure Criteria |
|---------------------|----------------|----------------------|---|
| Luminous Intensity | I _V | I _F =20mA | Testing Min. Value < Standard Min. Value × 0.5 |
| Forward Voltage | V _F | I _F =20mA | Testing Max. Value ≥ Standard Max. Value × 1.2 |
| Cosmetic Appearance | - | - | Notable discoloration, deformation and cracking |

VCEW1154LDS-3C4K3-TR

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